

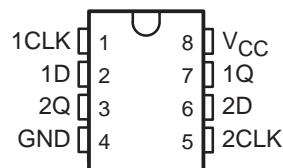
# SN74LVC2G79

## DUAL POSITIVE-EDGE-TRIGGERED D-TYPE FLIP-FLOP

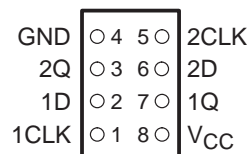
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- Available in the Texas Instruments NanoStar™ and NanoFree™ Packages
- Supports 5-V  $V_{CC}$  Operation
- Inputs Accept Voltages to 5.5 V
- Max  $t_{pd}$  of 4.2 ns at 3.3 V
- Low Power Consumption, 10- $\mu$ A Max  $I_{CC}$
- $\pm 24$ -mA Output Drive at 3.3 V
- Typical  $V_{OLP}$  (Output Ground Bounce)  $< 0.8$  V at  $V_{CC} = 3.3$  V,  $T_A = 25^\circ\text{C}$
- Typical  $V_{OHV}$  (Output  $V_{OH}$  Undershoot)  $> 2$  V at  $V_{CC} = 3.3$  V,  $T_A = 25^\circ\text{C}$
- $I_{off}$  Feature Supports Partial-Power-Down Mode Operation
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Protection Exceeds JESD 22
  - 2000-V Human-Body Model (A114-A)
  - 200-V Machine Model (A115-A)
  - 1000-V Charged-Device Model (C101)

DCT OR DCU PACKAGE  
(TOP VIEW)



YEP OR YZP PACKAGE  
(BOTTOM VIEW)



### description/ordering information

This dual positive-edge-triggered D-type flip-flop is designed for 1.65-V to 5.5-V  $V_{CC}$  operation.

When data at the data (D) input meets the setup time requirement, the data is transferred to the Q output on the positive-going edge of the clock pulse. Clock triggering occurs at a voltage level and is not directly related to the rise time of the clock pulse. Following the hold-time interval, data at the D input can be changed without affecting the levels at the outputs.

NanoStar™ and NanoFree™ package technology is a major breakthrough in IC packaging concepts, using the die as the package.

### ORDERING INFORMATION

| $T_A$         | PACKAGE†   |               | ORDERABLE PART NUMBER | TOP-SIDE MARKING‡ |
|---------------|--|---------------|-----------------------|-------------------|
| –40°C to 85°C | NanoStar™ – WCSP (DSBGA)<br>0.23-mm Large Bump – YEP           | Tape and reel | SN74LVC2G79YEPR       | ---CR_            |
|               | NanoFree™ – WCSP (DSBGA)<br>0.23-mm Large Bump – YZP (Pb-free) |               | SN74LVC2G79YZPR       |                   |
|               | SSOP – DCT   | Tape and reel | SN74LVC2G79DCTR       | C79_ _ _          |
|               | VSSOP – DCU  | Tape and reel | SN74LVC2G79DCUR       | C79_ _ _          |

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at [www.ti.com/sc/package](http://www.ti.com/sc/package).

‡ DCT: The actual top-side marking has three additional characters that designate the year, month, and assembly/test site.

DCU: The actual top-side marking has one additional character that designates the assembly/test site.

YEP/YZP: The actual top-side marking has three preceding characters to denote year, month, and sequence code, and one following character to designate the assembly/test site. Pin 1 identifier indicates solder-bump composition (1 = SnPb, • = Pb-free).



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

NanoStar and NanoFree are trademarks of Texas Instruments.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



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DUAL POSITIVE-EDGE-TRIGGERED D-TYPE FLIP-FLOP

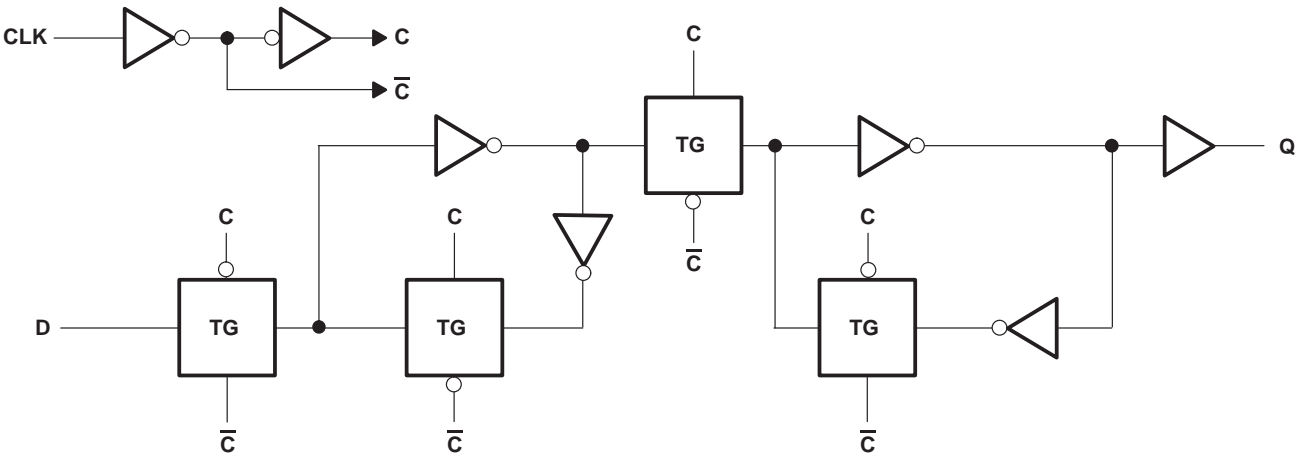
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description/ordering information (continued)

This device is fully specified for partial-power-down applications using  $I_{off}$ . The  $I_{off}$  circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

| FUNCTION TABLE |   |             |
|----------------|---|-------------|
| INPUTS         |   | OUTPUT<br>Q |
| CLK            | D |             |
| ↑              | H | H           |
| ↑              | L | L           |
| L              | X | $Q_0$       |

logic diagram, each flip-flop (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

|  |                            |
|--|----------------------------|
| Supply voltage range, $V_{CC}$                                     | –0.5 V to 6.5 V            |
| Input voltage range, $V_I$ (see Note 1)                            | –0.5 V to 6.5 V            |
| Output voltage range, $V_O$ (see Notes 1 and 2)                    | –0.5 V to $V_{CC} + 0.5$ V |
| Input clamp current, $I_{IK}$ ( $V_I < 0$ )                        | –50 mA                     |
| Output clamp current, $I_{OK}$ ( $V_O < 0$ )                       | –50 mA                     |
| Continuous output current, $I_O$                                   | ±50 mA                     |
| Continuous current through $V_{CC}$ or GND                         | ±100 mA                    |
| Package thermal impedance, $\theta_{JA}$ (see Note 3): DCT package | 220°C/W                    |
| DCU package  | 227°C/W                    |
| YEP/YZP package  | 102°C/W                    |
| Storage temperature range, $T_{stg}$                               | –65°C to 150°C             |

<sup>†</sup> Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.  
2. The value of  $V_{CC}$  is provided in the recommended operating conditions table.  
3. The package thermal impedance is calculated in accordance with JESD 51-7.

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## DUAL POSITIVE-EDGE-TRIGGERED D-TYPE FLIP-FLOP

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### recommended operating conditions (see Note 4)

|                     |                                    | MIN  | MAX                  | UNIT |
|---------------------|------------------------------------|--|----------------------|------|
| $V_{CC}$            | Supply voltage                     | Operating  | 1.65                 | 5.5  |
|                     |                                    | Data retention only  | 1.5                  |      |
| $V_{IH}$            | High-level input voltage           | $V_{CC} = 1.65\text{ V to }1.95\text{ V}$                                | $0.65 \times V_{CC}$ | V    |
|                     |                                    | $V_{CC} = 2.3\text{ V to }2.7\text{ V}$                                  | 1.7                  |      |
|                     |                                    | $V_{CC} = 3\text{ V to }3.6\text{ V}$                                    | 2                    |      |
|                     |                                    | $V_{CC} = 4.5\text{ V to }5.5\text{ V}$                                  | $0.7 \times V_{CC}$  |      |
| $V_{IL}$            | Low-level input voltage            | $V_{CC} = 1.65\text{ V to }1.95\text{ V}$                                | $0.35 \times V_{CC}$ | V    |
|                     |                                    | $V_{CC} = 2.3\text{ V to }2.7\text{ V}$                                  | 0.7                  |      |
|                     |                                    | $V_{CC} = 3\text{ V to }3.6\text{ V}$                                    | 0.8                  |      |
|                     |                                    | $V_{CC} = 4.5\text{ V to }5.5\text{ V}$                                  | $0.3 \times V_{CC}$  |      |
| $V_I$               | Input voltage                      | 0  | 5.5                  | V    |
| $V_O$               | Output voltage                     | 0  | $V_{CC}$             | V    |
| $I_{OH}$            | High-level output current          | $V_{CC} = 1.65\text{ V}$   | -4                   | mA   |
|                     |                                    | $V_{CC} = 2.3\text{ V}$  | -8                   |      |
|                     |                                    | $V_{CC} = 3\text{ V}$  | -16                  |      |
|                     |                                    |  | -24                  |      |
|                     |                                    | $V_{CC} = 4.5\text{ V}$  | -32                  |      |
| $I_{OL}$            | Low-level output current           | $V_{CC} = 1.65\text{ V}$   | 4                    | mA   |
|                     |                                    | $V_{CC} = 2.3\text{ V}$  | 8                    |      |
|                     |                                    | $V_{CC} = 3\text{ V}$  | 16                   |      |
|                     |                                    |  | 24                   |      |
|                     |                                    | $V_{CC} = 4.5\text{ V}$  | 32                   |      |
| $\Delta t/\Delta v$ | Input transition rise or fall rate | $V_{CC} = 1.8\text{ V} \pm 0.15\text{ V}, 2.5\text{ V} \pm 0.2\text{ V}$ | 20                   | ns/V |
|                     |                                    | $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$                                 | 10                   |      |
|                     |                                    | $V_{CC} = 5\text{ V} \pm 0.5\text{ V}$                                   | 5                    |      |
| $T_A$               | Operating free-air temperature     | -40  | 85                   | °C   |

NOTE 4: All unused inputs of the device must be held at  $V_{CC}$  or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

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## DUAL POSITIVE-EDGE-TRIGGERED D-TYPE FLIP-FLOP

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**electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)**

| PARAMETER        |         | TEST CONDITIONS  | V <sub>CC</sub> | MIN                  | TYP | MAX  | UNIT |
|------------------|---------|--|-----------------|----------------------|-----|------|------|
| V <sub>OH</sub>  |         | I <sub>OH</sub> = -100 µA  | 1.65 V to 5.5 V | V <sub>CC</sub> -0.1 |     |      | V    |
|                  |         | I <sub>OH</sub> = -4 mA  | 1.65 V          | 1.2                  |     |      |      |
|                  |         | I <sub>OH</sub> = -8 mA  | 2.3 V           | 1.9                  |     |      |      |
|                  |         | I <sub>OH</sub> = -16 mA   | 3 V             | 2.4                  |     |      |      |
|                  |         | I <sub>OH</sub> = -24 mA   |                 | 2.3                  |     |      |      |
|                  |         | I <sub>OH</sub> = -32 mA   | 4.5 V           | 3.8                  |     |      |      |
| V <sub>OL</sub>  |         | I <sub>OL</sub> = 100 µA   | 1.65 V to 5.5 V |                      |     | 0.1  | V    |
|                  |         | I <sub>OL</sub> = 4 mA   | 1.65 V          |                      |     | 0.45 |      |
|                  |         | I <sub>OL</sub> = 8 mA   | 2.3 V           |                      |     | 0.3  |      |
|                  |         | I <sub>OL</sub> = 16 mA  | 3 V             |                      |     | 0.4  |      |
|                  |         | I <sub>OL</sub> = 24 mA  |                 |                      |     | 0.55 |      |
|                  |         | I <sub>OL</sub> = 32 mA  | 4.5 V           |                      |     | 0.55 |      |
| I <sub>I</sub>   | D input | V <sub>I</sub> = 5.5 V or GND  | 0 to 5.5 V      |                      |     | ±1   | µA   |
| I <sub>off</sub> |         | V <sub>I</sub> or V <sub>O</sub> = 5.5 V                                     | 0               |                      |     | ±1   | µA   |
| I <sub>CC</sub>  |         | V <sub>I</sub> = 5.5 V or GND, I <sub>O</sub> = 0                            | 1.65 V to 5.5 V |                      |     | 5    | µA   |
| ΔI <sub>CC</sub> |         | One input at V <sub>CC</sub> - 0.6 V, Other inputs at V <sub>CC</sub> or GND | 3 V to 5.5 V    |                      |     | 500  | µA   |
| C <sub>i</sub>   |         | V <sub>I</sub> = V <sub>CC</sub> or GND                                      | 0               |                      | 3.5 |      | pF   |

† All typical values are at V<sub>CC</sub> = 3.3 V, T<sub>A</sub> = 25°C.

**timing requirements over recommended operating free-air temperature range (unless otherwise noted) (see Figure 2)**

|                    |                                 |           | V <sub>CC</sub> = 1.8 V<br>± 0.15 V |     | V <sub>CC</sub> = 2.5 V<br>± 0.2 V |     | V <sub>CC</sub> = 3.3 V<br>± 0.3 V |     | V <sub>CC</sub> = 5 V<br>± 0.5 V |     | UNIT |
|--------------------|---------------------------------|-----------|-------------------------------------|-----|------------------------------------|-----|------------------------------------|-----|----------------------------------|-----|------|
|                    |                                 |           | MIN                                 | MAX | MIN                                | MAX | MIN                                | MAX | MIN                              | MAX |      |
| f <sub>clock</sub> | Clock frequency                 |           | 160                                 |     | 160                                |     | 160                                |     | 160                              |     | MHz  |
| t <sub>w</sub>     | Pulse duration, CLK high or low |           | 2.5                                 |     | 2.5                                |     | 2.5                                |     | 2.5                              |     | ns   |
| t <sub>su</sub>    | Setup time<br>before CLK↑       | Data high | 2.2                                 |     | 1.4                                |     | 1.1                                |     | 0.9                              |     | ns   |
|                    |                                 | Data low  | 2.2                                 |     | 1.4                                |     | 1.1                                |     | 0.9                              |     |      |
| t <sub>h</sub>     | Hold time, data after CLK↑      |           | 1.4                                 |     | 0.8                                |     | 0.7                                |     | 0.5                              |     | ns   |

# SN74LVC2G79

## DUAL POSITIVE-EDGE-TRIGGERED D-TYPE FLIP-FLOP

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switching characteristics over recommended operating free-air temperature range,  $C_L = 15 \text{ pF}$  (unless otherwise noted) (see Figure 1)

| PARAMETER  | FROM<br>(INPUT) | TO<br>(OUTPUT) | $V_{CC} = 1.8 \text{ V} \pm 0.15 \text{ V}$ |     | $V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$ |     | $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ |     | $V_{CC} = 5 \text{ V} \pm 0.5 \text{ V}$ |     | UNIT |
|------------|-----------------|----------------|---|-----|--|-----|--|-----|--|-----|------|
|            |                 |                | MIN   | MAX | MIN  | MAX | MIN  | MAX | MIN                                      | MAX |      |
| $f_{\max}$ |                 |                | 160   |     | 160  |     | 160  |     | 160                                      |     | MHz  |
| $t_{pd}$   | CLK             | Q              | 3   | 9.1 | 1.5  | 6   | 1.3  | 4.2 | 1.1                                      | 3.7 | ns   |

switching characteristics over recommended operating free-air temperature range,  $C_L = 30 \text{ pF}$  or  $50 \text{ pF}$  (unless otherwise noted) (see Figure 2)

| PARAMETER  | FROM<br>(INPUT) | TO<br>(OUTPUT) | $V_{CC} = 1.8 \text{ V} \pm 0.15 \text{ V}$ |     | $V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$ |     | $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ |     | $V_{CC} = 5 \text{ V} \pm 0.5 \text{ V}$ |     | UNIT |
|------------|-----------------|----------------|---|-----|--|-----|--|-----|--|-----|------|
|            |                 |                | MIN   | MAX | MIN  | MAX | MIN  | MAX | MIN                                      | MAX |      |
| $f_{\max}$ |                 |                | 160   |     | 160  |     | 160  |     | 160                                      |     | MHz  |
| $t_{pd}$   | CLK             | Q              | 4.4   | 9.9 | 2.3  | 7   | 2  | 5.2 | 1.3                                      | 4.5 | ns   |

operating characteristics,  $T_A = 25^\circ\text{C}$

| PARAMETER |                               | TEST CONDITIONS      | $V_{CC} = 1.8 \text{ V}$ | $V_{CC} = 2.5 \text{ V}$ | $V_{CC} = 3.3 \text{ V}$ | $V_{CC} = 5 \text{ V}$ | UNIT |
|-----------|-------------------------------|----------------------|--------------------------|--------------------------|--------------------------|------------------------|------|
|           |                               |                      | TYP                      | TYP                      | TYP                      | TYP                    |      |
| $C_{pd}$  | Power dissipation capacitance | $f = 10 \text{ MHz}$ | 23                       | 23                       | 24                       | 28                     | pF   |



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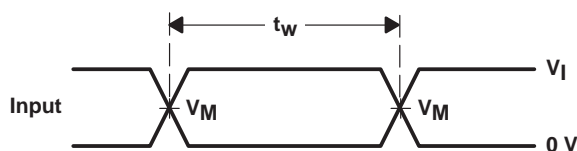
### PARAMETER MEASUREMENT INFORMATION



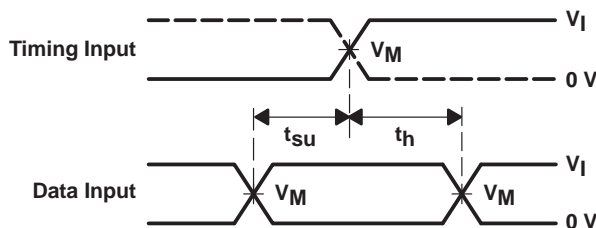
LOAD CIRCUIT

| TEST              | S1         |
|-------------------|------------|
| $t_{PLH}/t_{PHL}$ | Open       |
| $t_{PLZ}/t_{PZL}$ | $V_{LOAD}$ |
| $t_{PHZ}/t_{PZH}$ | $GND$      |

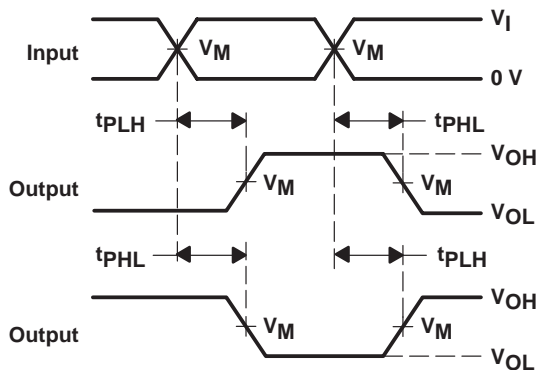
| $V_{CC}$           | INPUTS   |               | $V_M$      | $V_{LOAD}$        | $C_L$ | $R_L$        | $V_{\Delta}$ |
|--------------------|----------|---------------|------------|-------------------|-------|--------------|--------------|
|                    | $V_I$    | $t_r/t_f$     |            |                   |       |              |              |
| $1.8 V \pm 0.15 V$ | $V_{CC}$ | $\leq 2 ns$   | $V_{CC}/2$ | $2 \times V_{CC}$ | 15 pF | 1 M $\Omega$ | 0.15 V       |
| $2.5 V \pm 0.2 V$  | $V_{CC}$ | $\leq 2 ns$   | $V_{CC}/2$ | $2 \times V_{CC}$ | 15 pF | 1 M $\Omega$ | 0.15 V       |
| $3.3 V \pm 0.3 V$  | 3 V      | $\leq 2.5 ns$ | 1.5 V      | 6 V               | 15 pF | 1 M $\Omega$ | 0.3 V        |
| $5 V \pm 0.5 V$    | $V_{CC}$ | $\leq 2.5 ns$ | $V_{CC}/2$ | $2 \times V_{CC}$ | 15 pF | 1 M $\Omega$ | 0.3 V        |



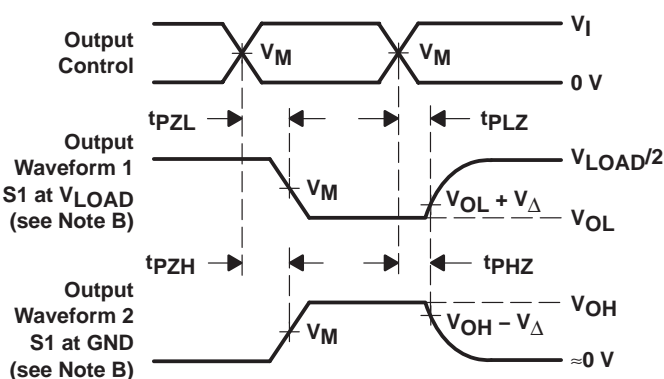
VOLTAGE WAVEFORMS  
PULSE DURATION



VOLTAGE WAVEFORMS  
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS  
PROPAGATION DELAY TIMES  
INVERTING AND NONINVERTING OUTPUTS



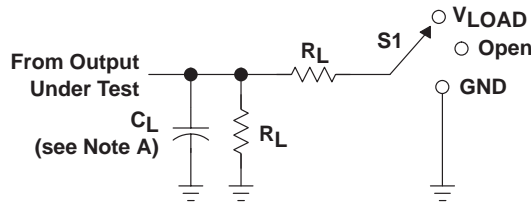
VOLTAGE WAVEFORMS  
ENABLE AND DISABLE TIMES  
LOW- AND HIGH-LEVEL ENABLING

- NOTES:
- $C_L$  includes probe and jig capacitance.
  - Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
  - All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10 MHz$ ,  $Z_O = 50 \Omega$ .
  - The outputs are measured one at a time with one transition per measurement.
  - $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
  - $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .
  - $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .
  - All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms



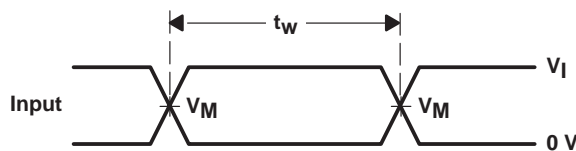
## PARAMETER MEASUREMENT INFORMATION



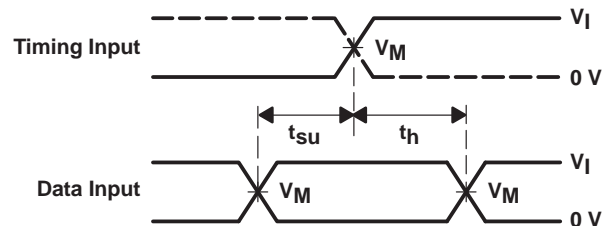
LOAD CIRCUIT

| TEST              | S1         |
|-------------------|------------|
| $t_{PLH}/t_{PHL}$ | Open       |
| $t_{PLZ}/t_{PZL}$ | $V_{LOAD}$ |
| $t_{PHZ}/t_{PZH}$ | GND        |

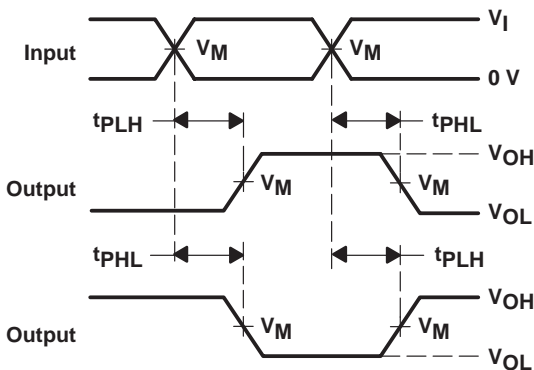
| $V_{CC}$                         | INPUTS   |                      | $V_M$      | $V_{LOAD}$        | $C_L$ | $R_L$        | $V_{\Delta}$ |
|----------------------------------|----------|----------------------|------------|-------------------|-------|--------------|--------------|
|                                  | $V_I$    | $t_r/t_f$            |            |                   |       |              |              |
| $1.8\text{ V} \pm 0.15\text{ V}$ | $V_{CC}$ | $\leq 2\text{ ns}$   | $V_{CC}/2$ | $2 \times V_{CC}$ | 30 pF | 1 k $\Omega$ | 0.15 V       |
| $2.5\text{ V} \pm 0.2\text{ V}$  | $V_{CC}$ | $\leq 2\text{ ns}$   | $V_{CC}/2$ | $2 \times V_{CC}$ | 30 pF | 500 $\Omega$ | 0.15 V       |
| $3.3\text{ V} \pm 0.3\text{ V}$  | 3 V      | $\leq 2.5\text{ ns}$ | 1.5 V      | 6 V               | 50 pF | 500 $\Omega$ | 0.3 V        |
| $5\text{ V} \pm 0.5\text{ V}$    | $V_{CC}$ | $\leq 2.5\text{ ns}$ | $V_{CC}/2$ | 11 V              | 50 pF | 500 $\Omega$ | 0.3 V        |



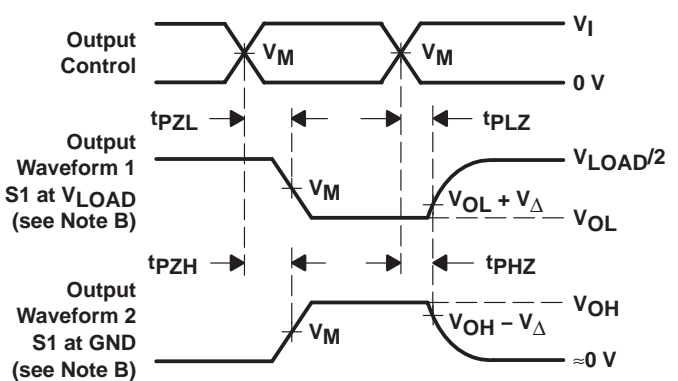
VOLTAGE WAVEFORMS  
PULSE DURATION



VOLTAGE WAVEFORMS  
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS  
PROPAGATION DELAY TIMES  
INVERTING AND NONINVERTING OUTPUTS



VOLTAGE WAVEFORMS  
ENABLE AND DISABLE TIMES  
LOW- AND HIGH-LEVEL ENABLING

- NOTES:
- A.  $C_L$  includes probe and jig capacitance.
  - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
  - C. All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10\text{ MHz}$ ,  $Z_O = 50\ \Omega$ .
  - D. The outputs are measured one at a time with one transition per measurement.
  - E.  $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
  - F.  $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .
  - G.  $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .
  - H. All parameters and waveforms are not applicable to all devices.

Figure 2. Load Circuit and Voltage Waveforms

## PACKAGING INFORMATION

| Orderable Device | Status <sup>(1)</sup> | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <sup>(2)</sup> | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> |
|------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|------------------|------------------------------|
| SN74LVC2G79DCTR  | ACTIVE                | SM8          | DCT             | 8    | 3000        | None                    | CU SNPB          | Level-1-235C-UNLIM           |
| SN74LVC2G79DCUR  | ACTIVE                | US8          | DCU             | 8    | 3000        | Pb-Free (RoHS)          | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LVC2G79YEPR  | ACTIVE                | WCSP         | YEP             | 8    | 3000        | None                    | SNPB             | Level-1-260C-UNLIM           |
| SN74LVC2G79YZPR  | ACTIVE                | WCSP         | YZP             | 8    | 3000        | Pb-Free (RoHS)          | SNAGCU           | Level-1-260C-UNLIM           |

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - May not be currently available - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**None:** Not yet available Lead (Pb-Free).

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean "Pb-Free" and in addition, uses package materials that do not contain halogens, including bromine (Br) or antimony (Sb) above 0.1% of total product weight.

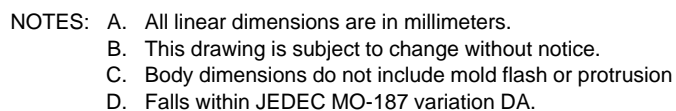
<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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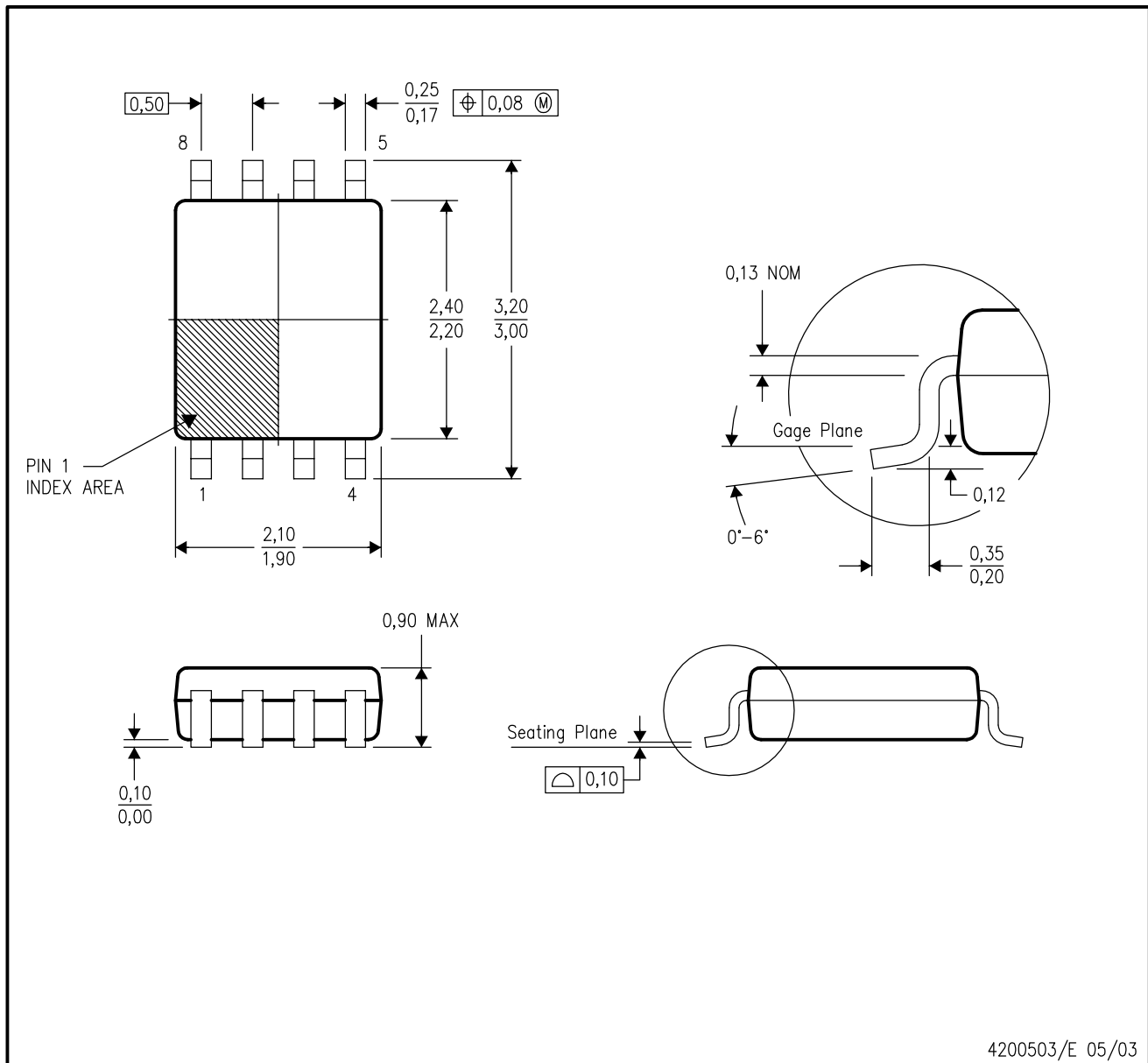


## PLASTIC SMALL-OUTLINE PACKAGE

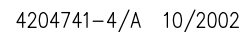


DCU (R-PDSO-G8)

PLASTIC SMALL-OUTLINE PACKAGE (DIE DOWN)



- NOTES:
- All linear dimensions are in millimeters.
  - This drawing is subject to change without notice.
  - Body dimensions do not include mold flash or protrusion.
  - Falls within JEDEC MO-187 variation CA.



A. All linear dimensions are in millimeters.  
B. This drawing is subject to change without notice.  
C. NanoFree™ package configuration.  
D. This package is lead-free. Refer to the 8 YEP package (drawing 4204725) for tin-lead (SnPb).

YEP (R-XBGA-N8)

DIE-SIZE BALL GRID ARRAY



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. NanoStar™ package configuration.
  - D. This package is tin-lead (SnPb). Refer to the 8 YZP package (drawing 4204741) for lead-free.

NanoStar is a trademark of Texas Instruments.

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